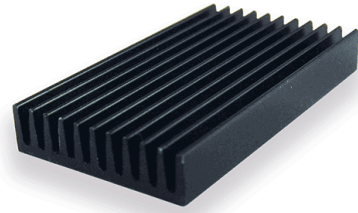


Product Data Sheet Type: PR8/33/SE

Group: HEATSINKS Board Level

For single mounting

Width : 18.9 mm
Height : 4.8 mm
Length : 33 mm
Minimum thermal resistance : 13 K/W
For device : DIL
Device mounted by :
Heatsink mounted by :
Surface :
Material : AIMgSi0,5



- Extruded heatsinks especially for IC's in DUAL IN LINE case.
- Mounting by single component thermal conductive adhesive type WK 709.
- Standard length:
 - 6,3 mm for 14/16 pins
 - 33 mm for 24 pins
 - 37 mm for 28 pins
 - 47 mm for 35 pins
 - 51 mm for 40 pins
- Other lengths and machining on request.

